



# CERAMIC BALUN

# RF Transformer

# TCW1-392+

50Ω 3300 to 3900 MHz 1:1 Ratio

## FEATURES

- Miniature size 0603 (1.6x0.8mm)
- LTCC construction
- Low cost



Generic photo used for illustration purposes only

CASE STYLE: JC0603C

### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

## APPLICATIONS

- LTE
- 5G
- A/D conversion

## ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio		1			
Frequency Range		3300	—	3900	MHz
Avg. Insertion Loss <sup>1</sup>	3300-3900	—	0.8	1.5	dB
Amplitude Unbalance	3300-3900	—	0.6	1.5	dB
Phase Unbalance <sup>2</sup>	3300-3900	—	5	15	Degree
VSWR	3300-3900	—	1.7	—	(:1)

1. Reference demo board TB-TCW1-392+

2. Relative to 180°

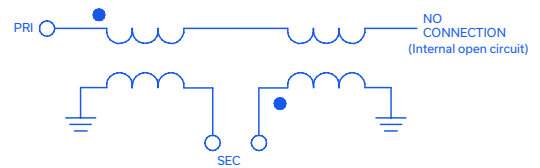
## MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power <sup>3</sup>	1W

3. Passband rating.

Permanent damage may occur if any of these limits are exceeded.

## CONFIGURATION J



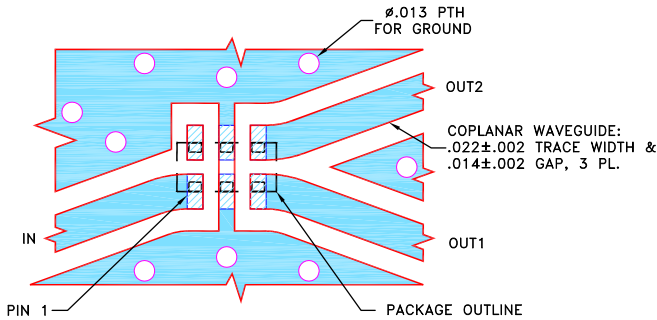


### PAD CONNECTIONS

PRIMARY DOT	1
PRIMARY	2
SECONDARY DOT	4
SECONDARY	3
NO CONNECTION	6
NOT USED	5

PRODUCT MARKING: N/A

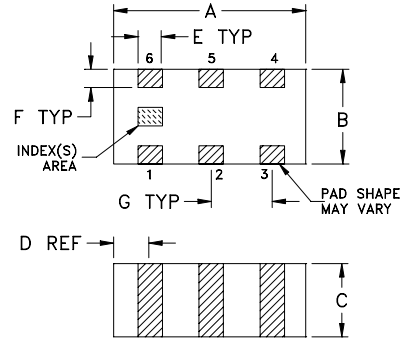
### DEMO BOARD MCL P/N: TB-TCW1-392+ SUGGESTED PCB LAYOUT (PL-513)



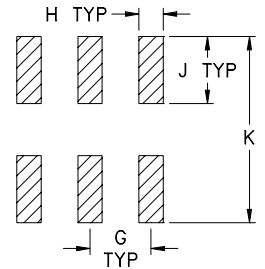
- TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS  $.010 \pm .001$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

### OUTLINE DRAWING



### PCB Land Pattern



Suggested Layout, Tolerance to be within  $\pm .002$

### OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.063	.031	.024	.012	.008	.006
1.60	0.79	0.61	0.30	0.20	0.15
G	H	J	K	wt	
.020	.010	.022	.053	grams	
0.51	0.25	0.56	1.35	0.005	

### TAPE & REEL INFORMATION: F114



# CERAMIC BALUN

# RF Transformer

# TCW1-392+

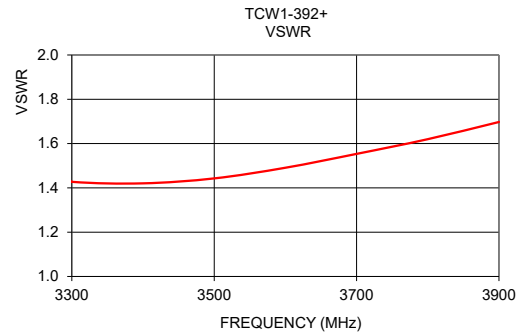
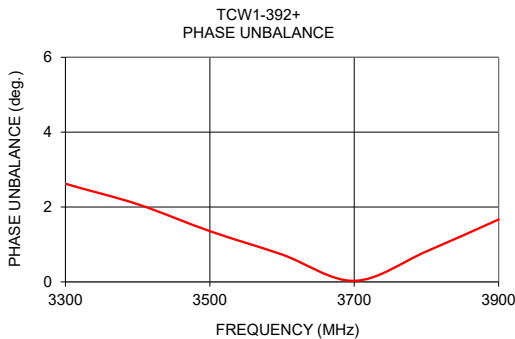
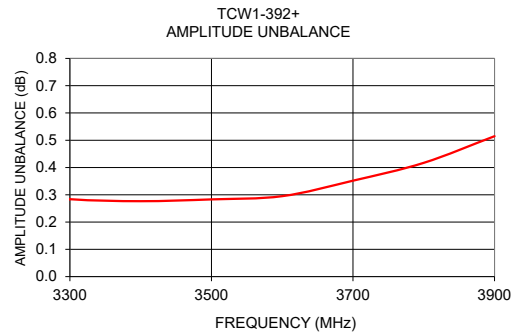
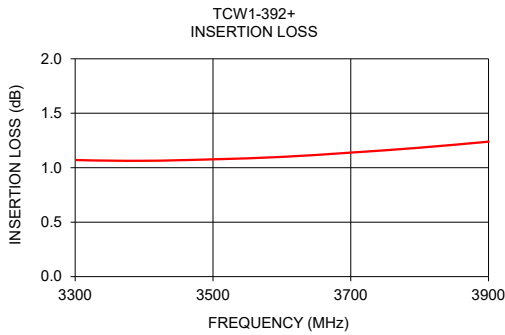


50Ω 3300 to 3900 MHz 1:1 Ratio

### TYPICAL PERFORMANCE DATA<sup>4</sup>

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
3300	1.07	1.43	0.28	2.62
3200	1.10	1.47	0.31	3.22
3300	1.07	1.43	0.28	2.62
3400	1.06	1.42	0.28	2.07
3500	1.08	1.44	0.28	1.36
3600	1.10	1.49	0.29	0.73
3700	1.14	1.55	0.35	0.03
3800	1.18	1.62	0.42	0.81
3900	1.24	1.70	0.51	1.67

4. Measured with Agilent N5242A network analyzer using impedance conversion and port extension.



#### NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/terms/viewterm.html](http://www.minicircuits.com/terms/viewterm.html)



## Typical Performance Data

FREQUENCY (MHz)	AVERAGE INSERTION LOSS* (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE** (deg.)
3000	1.21	12.40	0.39	4.16
3020	1.20	12.64	0.38	4.05
3040	1.18	12.86	0.37	3.95
3060	1.17	13.07	0.36	3.89
3080	1.16	13.27	0.36	3.79
3100	1.15	13.52	0.35	3.69
3120	1.14	13.72	0.34	3.60
3140	1.13	13.91	0.33	3.52
3160	1.12	14.12	0.33	3.36
3180	1.11	14.31	0.31	3.28
3200	1.11	14.45	0.31	3.22
3220	1.10	14.63	0.31	3.07
3240	1.10	14.84	0.30	2.93
3260	1.09	14.90	0.29	2.86
3280	1.08	15.02	0.30	2.75
3300	1.08	15.09	0.28	2.62
3320	1.08	15.18	0.29	2.56
3340	1.08	15.24	0.28	2.39
3360	1.07	15.26	0.28	2.28
3380	1.07	15.26	0.27	2.18
3400	1.07	15.20	0.28	2.07
3420	1.07	15.16	0.28	1.90
3440	1.08	15.14	0.27	1.80
3460	1.08	15.11	0.28	1.70
3480	1.08	14.96	0.28	1.56
3500	1.09	14.83	0.28	1.36
3520	1.09	14.69	0.27	1.30
3540	1.10	14.56	0.29	1.17
3560	1.10	14.44	0.29	0.97
3580	1.10	14.32	0.29	0.86
3600	1.11	14.11	0.29	0.73
3620	1.12	13.91	0.31	0.62
3640	1.12	13.76	0.32	0.43
3660	1.13	13.64	0.33	0.26
3680	1.14	13.49	0.34	0.16
3700	1.15	13.28	0.35	0.03
3720	1.16	13.10	0.35	0.20
3740	1.17	12.94	0.37	0.29
3760	1.18	12.76	0.39	0.48
3780	1.18	12.66	0.40	0.64
3800	1.19	12.52	0.42	0.81
3820	1.21	12.32	0.44	0.96
3840	1.22	12.13	0.45	1.16
3860	1.23	12.01	0.47	1.32
3880	1.24	11.88	0.50	1.49
3900	1.25	11.75	0.51	1.67
3920	1.26	11.60	0.53	1.87
3940	1.27	11.46	0.56	2.00
3960	1.28	11.35	0.58	2.23
3980	1.29	11.24	0.61	2.38
4000	1.30	11.17	0.64	2.59
4020	1.32	11.03	0.66	2.75
4040	1.33	10.88	0.70	2.97
4060	1.35	10.77	0.72	3.16
4080	1.36	10.71	0.76	3.32
4100	1.36	10.63	0.80	3.58
4120	1.38	10.57	0.83	3.79
4140	1.39	10.48	0.86	3.96
4160	1.40	10.38	0.91	4.16
4180	1.42	10.28	0.94	4.47
4200	1.43	10.24	0.97	4.63
4220	1.44	10.19	1.02	4.85
4240	1.45	10.11	1.07	5.11
4260	1.46	10.03	1.11	5.38
4280	1.48	9.97	1.15	5.55
4300	1.49	9.96	1.21	5.79

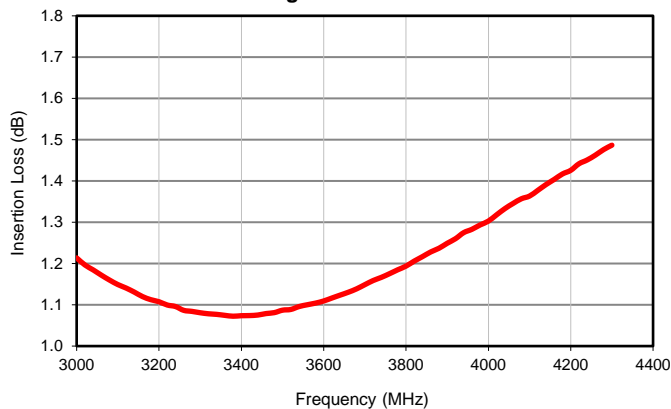
\* Reference Demo Board TB-828+

\*\*Phase Unbalance is relative to 180°

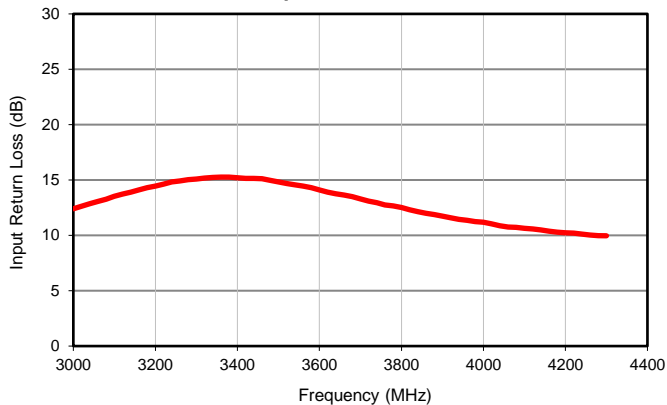


## Typical Performance Data

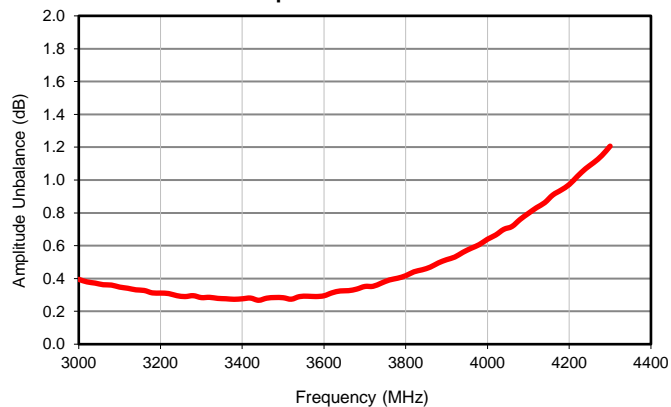
### Average Insertion Loss



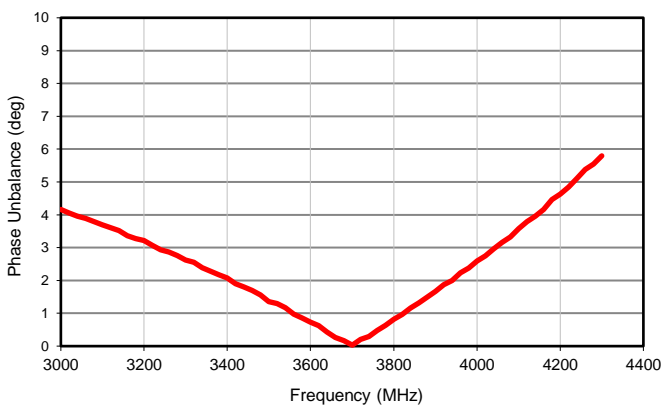
### Input Return Loss



### Amplitude Unbalance

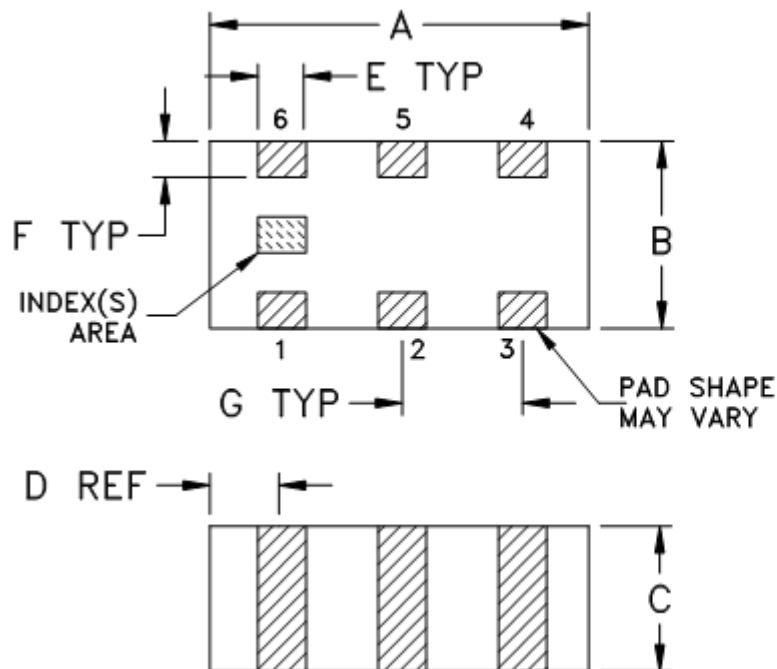


### Phase Unbalance

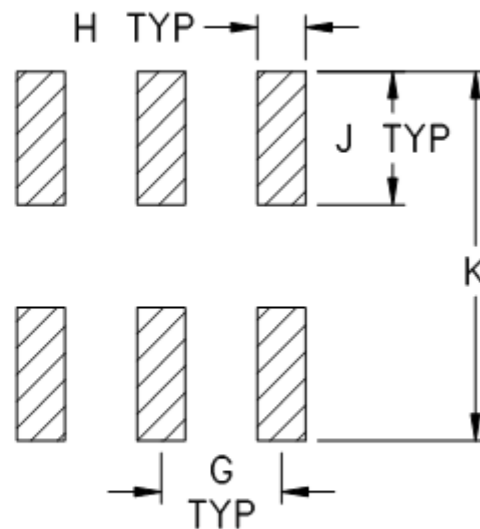


## Outline Dimensions

JC0603C



## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
JC0603C	.063 (1.60)	.031 (0.80)	.024 (0.60)	.012 (0.30)	.008 (0.20)	.006 (0.15)	.020 (0.50)	.010 (0.25)	.022 (0.55)	0.053 (1.35)	.005

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

### Notes:

- Open style, ceramic base.
- Termination finish:  
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.



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RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F114

## DEVICE ORIENTATION IN T&R

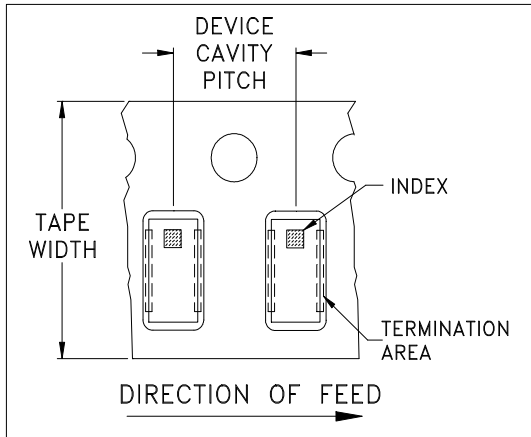


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

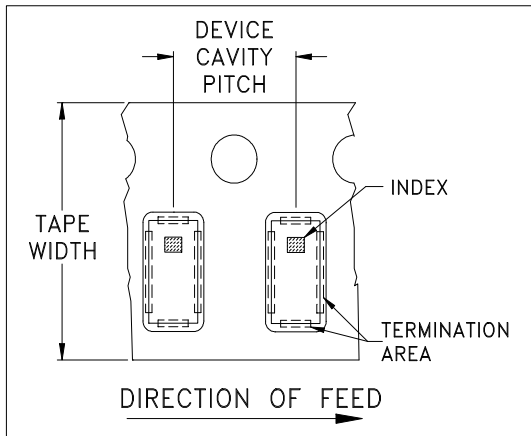


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



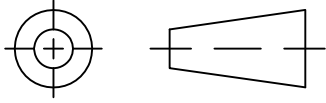
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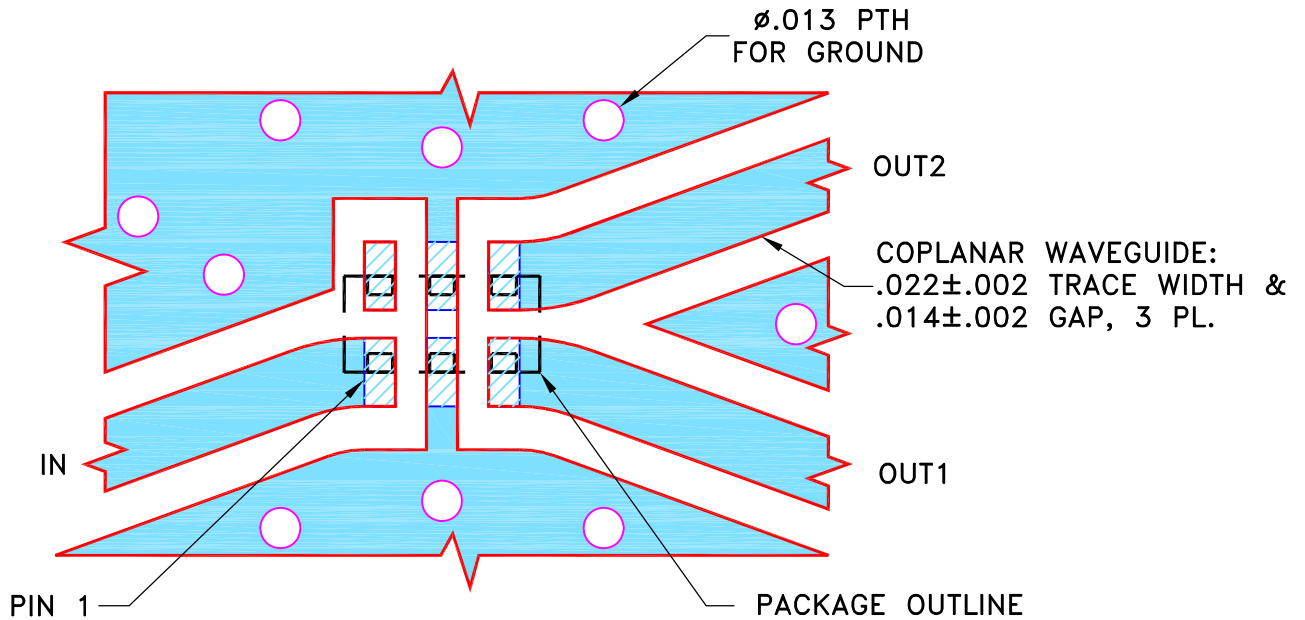
THIRD ANGLE PROJECTION




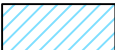
REVISIONS

REV OR	ECN No.	DESCRIPTION	DATE	DR	AUTH
	M162337	NEW RELEASE	06/15/17	ITG	AVB

**SUGGESTED MOUNTING CONFIGURATION  
FOR JC0603C CASE STYLE, "06TR01" PIN CODE**



- TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS  $.010 \pm .001$ ". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

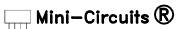
 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).  
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	ITG	06/14/17
	CHECKED	GF	06/15/17
	APPROVED	AVB	06/15/17

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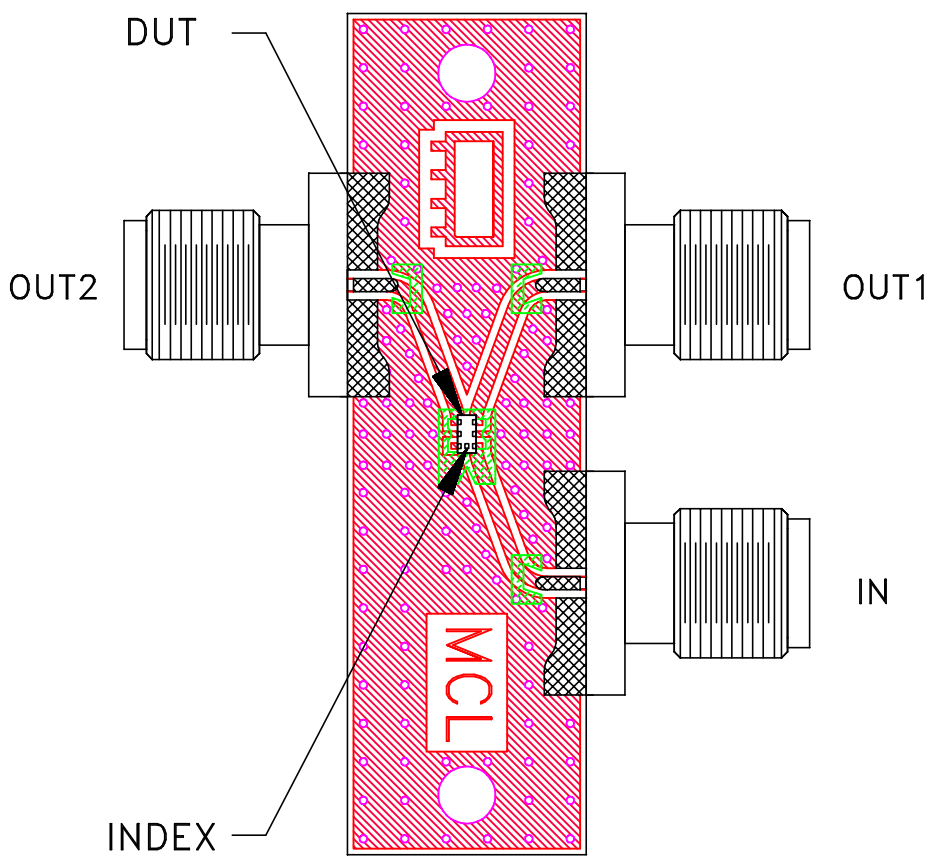
**PL, 06TR01, JC0603C, TB-828+**

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-513	OR
FILE:	98PL513	SCALE: 16:1	SHEET: 1 OF 1

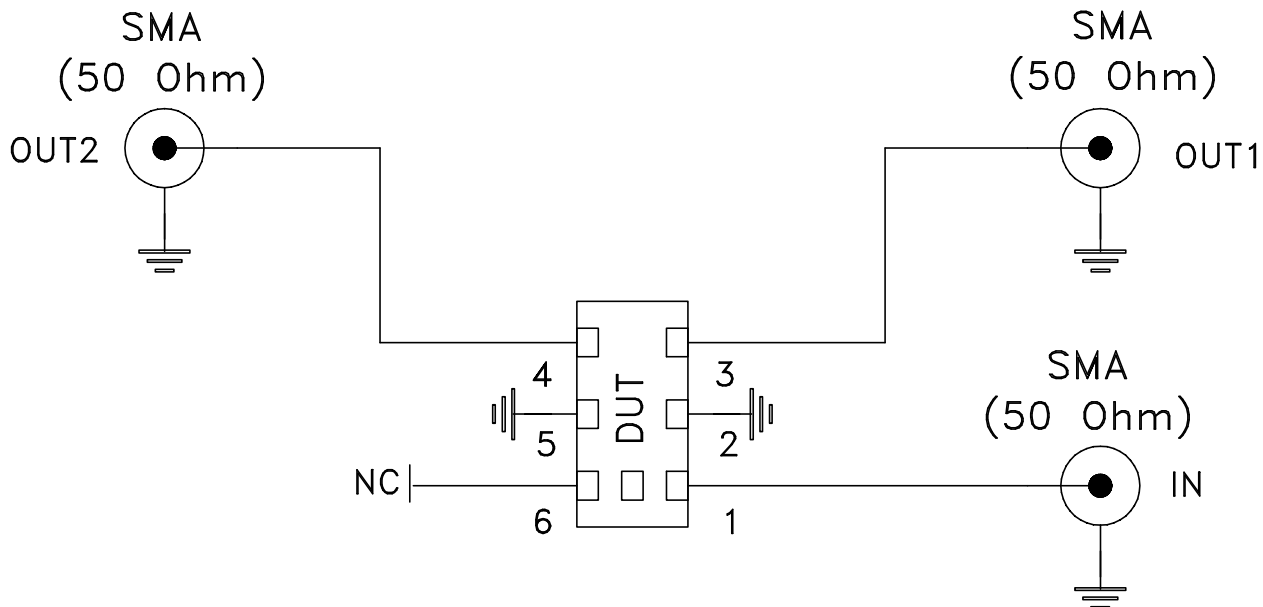
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# Evaluation Board and Circuit



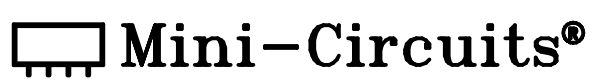
TB-828+



Schematic Diagram

**Notes:**

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent,  
Dielectric Constant=3.5, Thickness=.010 inch.



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215